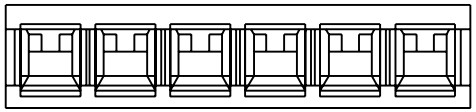
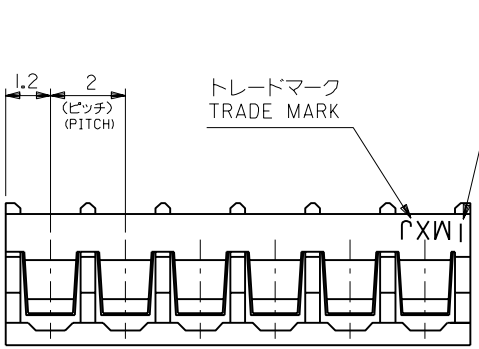
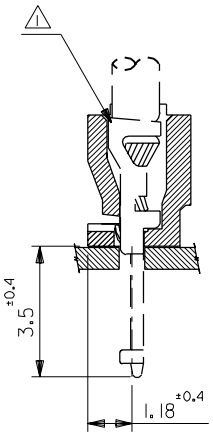
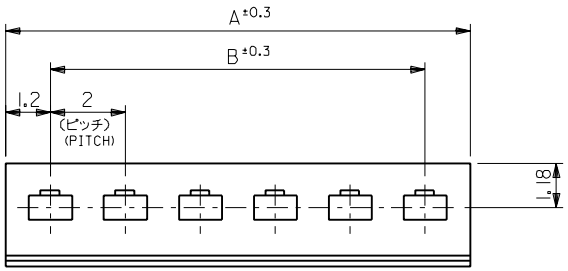
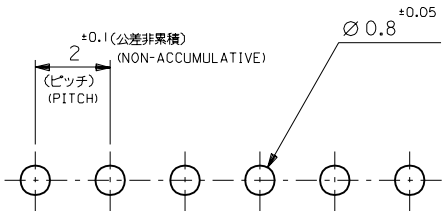
DWG. NO. SD-51015-**00











基板取付穴推奨寸法

(基板厚：t＝1～1。6mm)
RECOMMENDED PC BOARD
HOLE DIMENSION
(THICKNESS:t=1～1.6mm)

注記
NOTE

⚠ 適合ターミナル：50034－8＊00
APPLICABLE TERMINAL:50034-8*00

28	30.4	51015-1500	15
26	28.4	-1400	14
24	26.4	-1300	13
22	24.4	-1200	12
20	22.4	-1100	11
18	20.4	-1000	10
16	18.4	-0900	9
14	16.4	-0800	8
12	14.4	-0700	7
10	12.4	-0600	6
8	10.4	-0500	5
6	8.4	-0400	4
4	6.4	-0300	3
2	4.4	51015-0200	2
B	A	ENG.NO.	極数 NO. OF CKT

:MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING

角度 ANGLE	±3°
30 以上 OVER	±0.3
10 以上 OVER 30 未満 UNDER	±0.25
10 未満 UNDER	±0.2
一般公差 GENERAL TOLERANCES	

LTR	REVISION RECORD	DR.	DATE
B	再作図 REDRAWN (JC70310)	h.i M.F	'96/05/20

材料 MATERIAL
ナイロン66、UL94V-0
NYLON66,UL94V-0

仕上げ FINISH

適用電線範囲 WIRE RANGE

被覆外径 INS. RANGE

DRAWN BY '96/05/28 H.IIJIMA
CHK'D BY '96/05/28 M.FUKUSHIMA
APP'D BY '96/05/28 M.ENOMOTO
尺度 SCALE 8 : 1

MOLEX-JAPAN CO.,LTD.
日本モレックス株式会社

REVISE ONLY ON CAD SYSTEM

TITLE 名称
2.0 BOARD IN CONN. HSG.

DWG. NO. SD-51015-**00
REV B

5101S.S20

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